# Optoelectronics Cree ML-E White Series on Linear Board

## Cree ML-E White Series

The lighting class ½-watt XLamp ML-E LED brings high performance and a smooth look to a wide range of lighting applications, including linear lighting, LED replacement lamps, fluorescent retrofits and retail-display lighting.

#### **FEATURES**

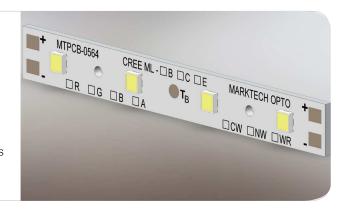
> Wide Viewing Angle: 120° > Thermal Resistance: 11°C/W

> Maximum Drive Current: 0.5A for MLEAWT

0.167A for MLESWT

### **APPLICATIONS**

- > Linear Lighting
- > Fluorescent Retrofits
- > Retail Display



## Flux Characteristics (T<sub>i</sub>=25°C--White)(per LED)





	7.11	,	lead-free ROHS
COLOR TEMPERATURE	CCT(TYP.)(°K)*	MIN.FLUX (LM) @150MA	KIT USED
Cool White	47505250	45.7	03E3
Neutral White	37004300	45.7	03E5
Warm White	28003200	39.8	02E7

\*See Cree Specifications

## \*Absolute Maximum Ratings (Note 1)

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ITEMS	SYMBOL	RATING	UNIT
Forward Current (Parallel Chip White MLEAWT)	l <sub>F</sub>	500	mA
Forward Current (Series Chip White MLESWT)	I <sub>F</sub>	167	mA
Forward Voltage (TYPICAL)(@150mA)(Parallel Chip White MLEAWT)	$V_{F}$	12.8	V
Forward Voltage (TYPICAL)(@50mA)(Series Chip White MLESWT)	$V_{F}$	38.4	V
Reverse Voltage (All White)	$V_{R}$	-20.0	V
Operating Temperature at T <sub>c</sub> Point (Note 2&3))	T <sub>OPR</sub>	100	0 <b>C</b>
Junction Temperature	T <sub>J</sub>	150	°C
ESD Classification (HBM per MIL-STD-883D)		Class 2	

- \* Exceeding maximum ratings may damage the LED and cause potential safety hazards.
- \* Elevated operating temperatures can be expected to negatively impact the service life (lumen output)
- \* All data is related to entire assembly. Data reflects statistical mean values. Actual data may differ depending on variances in the manufacturing process.
- \* End users need to take into account the lumen depreciation as the temperature rises with various thermal solutions installed.
- \* It is highly recommended for the user to review the CREE ML-E Series page for additional and most recent technical data at http://www.cree.com/led-components-and-modules/products/xlamp/discrete-nondirectional/xlamp-mle

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- Note 1: Using continuously under elevated loads (i.e. the application of high temperature/current/voltage or a significant change in temperature, etc.) may cause this product to significantly decrease in reliability even if the operating conditions are within the absolute maximum ratings.
- Note 2: The thermal resistance from the LED junction to ambient temperature, Rth(j-a), should be kept below 20°C/W (all colors) so that the LED is not exposed to a condition beyond the absolute maximum ratings.
- Note 3: The temperature of the LED assembly must be measured at the  $T_B$ -point according to EN60598-1 in a thermally constant status with a temperature sensor or a temperature sensitive label.

## Hardware (not included)

- > Mount with M1.6 Machine Screws.
- > 18AWG Maximum Wire Gauge.
- > Use only with constant current power supplies.

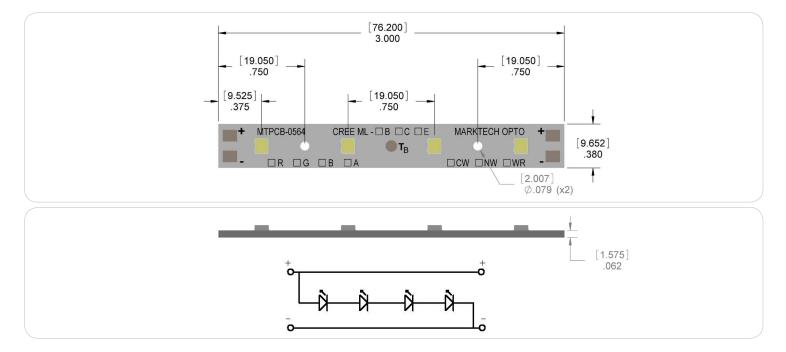
#### **PCB** Fabrication

> Layer Count: 1

Core Material: 6061-T6 AluminumSingle Layer Copper Weight: 1oz

> Solder Mask: White

> Finishing Plating: Pb Free HASL



The information contained herein is subject to change without notice.

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